



上海立凯电控科技有限公司

Shanghai LineKey Technology Co., Ltd.



Specification For Approval

规格书

客户名称:

部件名称:

叠层射频电感

客户料号:

立凯料号:

HFM0603-0N8B

供方确认			客户确认
制作	审核	核准	
吴子晗	薄双燕	陈余想	

Spec 变更记录:

版本	序号	更改描述	更改原因	备注
A0	01	Released		

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1. Scope

This specification applies to the HFM0603-0N8B of SMD multilayer RF inductor.

2. Product Description and Identification (Part Number)

HFM 0603 - 0N8 B
 ① ② ③ ④



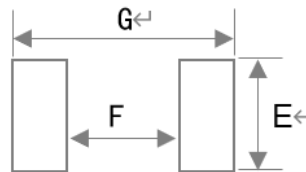
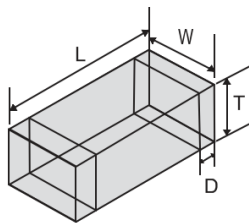
- ① Product Series: HFM Series
- ② Size: 0.6mm×0.3mm×0.3mm
- ③ Inductance: 0N8 = 0.8nH
- ④ Tolerance: B=±0.1nH

3. Operating & Storage Temperature

1) Operating temperature range : -55℃ ~ +125℃ (Including Self-heating) .

4. Shape and Dimensions (Unit: mm)

Dimensions and recommended PCB pattern for reflow soldering



Series	L(mm)	W(mm)	T(mm)	D(mm)	E(mm)	F(mm)	G(mm)
HFW0603	0.6±0.03	0.3±0.03	0.3±0.03	0.15±0.05	0.3 Typ.	0.3 Typ	0.8 Typ.

5. Electrical Characteristics

Part Number	Inductance (nH)	Tolerance	Q Value (Min)	Test Freq. L/Q (MHz)	SRF Min. (GHz)	DCR Max(Ω)	Rated Current Max (mA)
HFM0603-0N8B	0.8	±0.1nH	14	500	10	0.06	900

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客户/CLIENT:

型号/MODEL:

HFM0603-0N8B

承制方/MANUFACTURER: 上海立凯电控科技有限公司

版本/REV.: A0

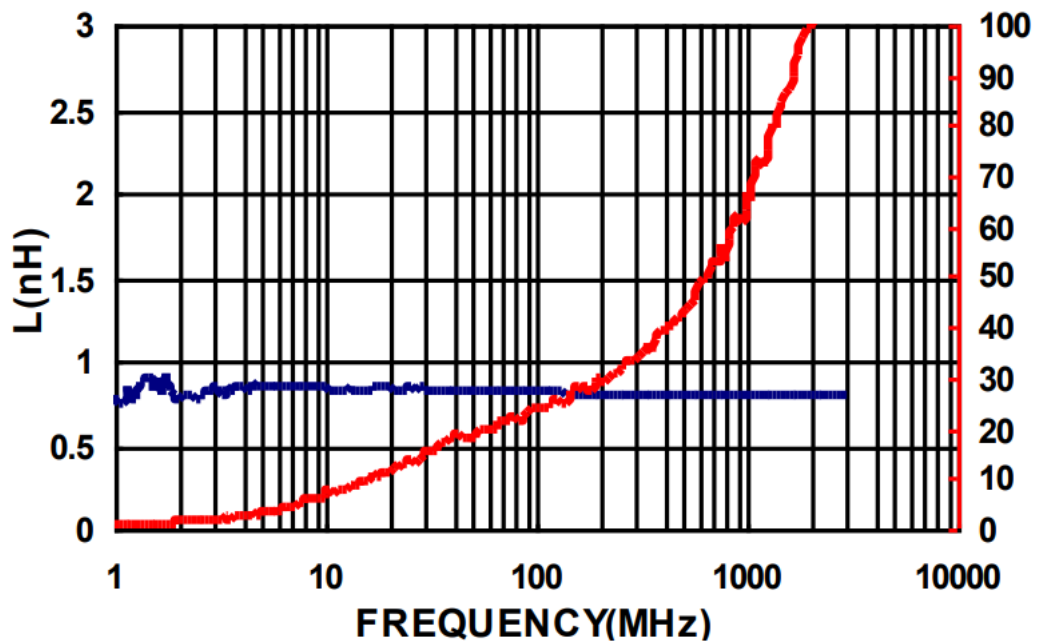
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Note*

- 1) Rated Current: Max. DC current which causes 20K temperature rise from 20° C ambient;
- 2) Measuring Instrument: L/Q:CH-1062, DCR: HIOKI-3540, Rated Current:CH-1062

6. Typical Characteristic Chart

L/Q Vs. Frequency



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承制方/MANUFACTURER: 上海立凯电控科技有限公司

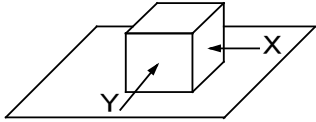
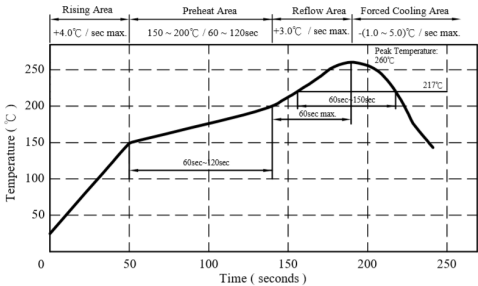
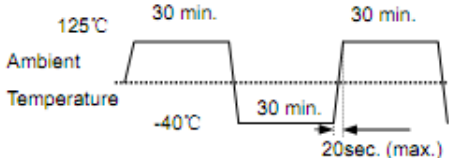
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6. Reliability Test

Items	Requirements	Test Methods and Remarks
6.1 Terminal Strength		<ol style="list-style-type: none"> 1) Solder the inductor to the testing jig using eutectic solder. Then apply a force in the direction of the arrow. 2) No removal or split of the termination or other defects shall occur. 3) 10N force. 4) Keep time: 5±2s.
6.2 High Temperature	<ol style="list-style-type: none"> 1) No visible mechanical damage. 2) Inductance change: Within ±10% 	<ol style="list-style-type: none"> 1) Storage Temperature :125+/-5°C. 2) Duration: 96 ±4 Hours. 3) Recovery: then measured at room ambient temperature after placing 24 hours.
6.3 Low Temperature	<ol style="list-style-type: none"> 1) No visible mechanical damage. 2) Inductance change: Within ±10% 	<ol style="list-style-type: none"> 1) Storage Temperature :125+/-5°C 2) Duration: 96 ±4 Hour. 3) Recovery: then measured at room ambient temperature after placing 24 hours.
6.4 Vibration test	<ol style="list-style-type: none"> 1) No visible mechanical damage. 2) Inductance change: Within ±10% 	<ol style="list-style-type: none"> 1) Frequency range:10HZ~55HZ~10HZ. 2) Amplitude:1.5mm p-p. 3) Direction: X, Y, Z. 4) Time:1 minute/cycle,2hours per axis
6.5 High Temperature Storage Tested	<ol style="list-style-type: none"> 1) No visible mechanical damage. 2) Inductance change: Within ±10% 	<ol style="list-style-type: none"> 1) Storage Temperature :60+/-2°C. 2) Relative Humidity:90-95% RH. 3) Duration: 96 ±4 Hours. 4) Recovery: then measured at room ambient temperature after placing 24 hours.
6.6 Resistance to Soldering Heat	<ol style="list-style-type: none"> 1) No visible mechanical damage. 2) Inductance change: Within ±10% 	<ol style="list-style-type: none"> 1) Re-flowing Profile: Please refer to the left graph. 2) Test board thickness: 1.0mm. 3) Test board material: glass epoxy resin. 4) The chip shall be stabilized at normal condition for 1~2 hours before measuring.
6.7 Thermal Shock	<ol style="list-style-type: none"> 1) No visible mechanical damage. 2) Inductance change: Within ±10% 	<ol style="list-style-type: none"> 1) Temperature and time: -40±3°C for 30±3 min→105°C for 30±3min, please refer to the left graph. 2) Transforming interval: Max, 3 minutes 3) Tested cycle: 100 cycles. 4) The chip shall be stabilized at normal condition for 1~2 hours before measuring.

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